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### 1 Description

The Micro Modular Technologies MN5010HS Global Positioning System (GPS) Receiver Module is a complete 20-channel receiver with high sensitivity that measures only 10 x 10 x 1.9 mm. It features fast-acquisition hardware, integrated RF filtering, TCXO, reset circuit, real-time clock with on-board crystal, and an integrated LNA that allows operation with either active or passive antennas. The user needs only provide DC power and a GPS signal; the MN5010HS will output the navigation solution in the widely-used NMEA-0183 protocol or in SiRF binary protocol.

The 20-channel receiver allows all satellites in view to be tracked, providing an over-determined solution to minimize position jumps caused by individual satellite blockage. The fast-acquisition hardware design greatly reduces the time for signal acquisition when the receiver is initially powered up. The MN5010HS operates from a single battery supply between 3.25 and 5.5 VDC. For even further power reductions, the OEM design may use a power-saving mode via binary commands.

The MN5010HS is supported by an evaluation kit, including software, along with reference designs to speed OEM development. The MN5010HS is machine placeable by standard surface mount equipment and is available in tube or tape and reel. A metal shield is provided for RF protection and for automated nozzle pickup.

#### 1.1 Features

- Complete SiRFstarIII-based 20-channel GPS receiver
- Highly integrated design includes on-board LNA, TCXO, RF filtering, Reset circuit, and a Real Time Clock circuit with crystal
- Ultra-small 10 x 10 x 1.9 mm 36-pin LGA package
- Less than 80 mW typical power consumption
- Fast-acquisition design for rapid position determination under all startup and operating conditions.
- Extended commercial temperature operation (-20℃ to +85℃)
- Supports active or passive antennas
- Supports SBAS (WAAS, EGNOS, MSAS, GAGAN)
- Standard serial protocols: NMEA-0183 or SiRF binary
- Evaluation kit available
- Pb free RoHS compliant

#### 1.2 Block Diagram

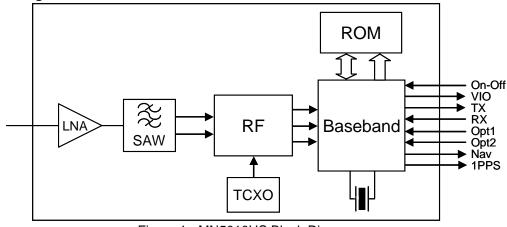


Figure 1 - MN5010HS Block Diagram



**MN5010HS** 

1.03

85G

U0061

#### 1.3 GPS Performance

Acquisition Time	Specification
Cold start TTFF (no time, no position, no ephemeris)	<35 seconds
Warm start TTFF (approximate time and position, no ephemeris)	<35 seconds
Hot Start TTFF (time, position and ephemeris)	<1 second

Table 1 – Acquisition Performance

Horizontal Position Error	Accuracy
CEP	<2.5 meters

Table 2 – Horizontal Position Accuracy

Sensitivity	Typical
Tracking	-159 dBm
Acquisition (Cold Start)	-142 dBm

Table 3 – Sensitivity

### 2 Environmental Limits

#### 2.1 Operating

Temperature	-20°C to +85°C
Humidity	Up to 95% non-condensing or a wet bulb temperature of +35°C, whichever is less
Altitude	-1000 feet to 60,000 feet

#### Table 4 – Operating Limits

#### 2.2 Storage

Temperature	-40℃ to +85℃	
Humidity	Up to 95% non-condensing or a wet bulb temperature of +35℃, whichever is less	
Altitude	-1000 feet to 60,000 feet	
Shock	18G peak, 5 millisecond duration	
Shock (in shipping container)	10 drops from 75 cm onto concrete floor	

Table 5 – Storage Limits

### 3 Electrical

### 3.1 Module Pin Descriptions

Pin	Name	Pin Definition		
2	GND	Ground		
4	RESERVED	This pin must be grounded, preferably through a zero $\Omega$ resistor.		
7	RXO	The MN5010HS GPS Receiver Module implements a single full-duplex asynchronous serial UART port. This signal is used to input commands to the receiver in either NMEA or SiRF binary protocol, depending upon the configuration of the receiver. In the idle condition, this pin is at logic 1. If the driving circuitry is powered independently of the MN5010HS, ensure that this pin is not driven to logic 1 when primary power to the MN5010HS is removed or when the MN5010HS is in the Hibernate state.		
8	ТХО	The MN5010HS GPS Receiver Module implements a single full-duplex asynchronous serial UART port. This signal is used to output position, time and velocity information from the receiver in either NMEA or SiRF binary protocol, depending upon the configuration of the receiver. In the idle condition, this pin is at logic 1. In the Hibernate state, this pin will be at logic 0.		
9	1PPS	One-pulse-per-second (1PPS) output, synchronized when the fix is valid. The pulse duration is 1 $\mu$ s, and its rate is 1 Hz. See section 3.4.3, 1PPS Signal.		
11	GND	Ground		
12	VIO	I/O voltage (output). This pin may be used to determine the current state of the module (Off or Hibernate). VIO can supply a maximum of 5 mA.		
13	OPT1	This input signal is used (with OPT2) to configure the operation of the MN5010HS. Please refer to the MN5010HS Design Guidelines document for more information regarding use of this pin.		
14	OPT2	This input signal is used (with OPT1) to configure the operation of the MN5010HS. Please refer to the MN5010HS Design Guidelines document for more information regarding use of this pin.		
20	NAV	This output signal indicates navigation status. It pulses high for 100 ms each second when the receiver is in navigation (i.e., the fix is valid), and steady low when the receiver is not in navigation.		
22	ON-OFF	An input pulse toggles the state of the module between On and Hibernate. To toggle the state, pulse this pin high for a minimum of 1 ms. Maximum pulse rate is one per second.		
23	nMR	This input signal is pulled low for at least 30 ms to reset the MN5010HS. If the user does not need this signal, it may be left unconnected. This signal will also wake up an MN5010HS receiver that is in the HIBERNATE state. Internally, this pin is a 1.2V logic level. It may not be driven by any source; it may only be pulled to ground. Please refer to the MN5010HS Design Guidelines document for more information regarding use of this pin.		
24	GND	Ground		
27	GND	Ground		
29	GND	Ground		

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Pin	Name	Pin Definition	
30	ANT	RF input: Connect to external antenna. See Section 3.3, RF Interface.	
31	GND	Ground	
33	BATTERY	Power supply to module (+3.25 to +5.5 VDC)	

Table 6 – MN5010HS Pin-out

Note: The following pins have no internal connection: 1, 3, 5, 6, 10, 15-19, 21, 25, 26, 28, 32, 34-36. Caution: The input pins are not 3V tolerant. See Table 9 – Digital I/O Interface Levels.

#### 3.2 Power Supply

The MN5010HS GPS Receiver Module is designed to operate from a single supply, typically from a Lithium Ion battery.

Voltage	3.25 to 5.5 VDC
Current (typical)	26.5 mA
Current (maximum)	37 mA
Current - hibernate state – (maximum)	25 μΑ

Table 7 – Main Power Supply

#### 3.3 RF Interface

#### 3.3.1 RF Input

The MN5010HS GPS Receiver Module accepts a GPS L1 C/A signal from an industry-standard GPS antenna (which may be passive or active). If a passive antenna is used, no other circuitry is required. However, if an active antenna is required, then suitable means for powering the active antenna must be provided external to the MN5010HS GPS Receiver Module. The RF input is isolated from DC levels to a maximum of  $\pm$ 15 VDC.

If the design is required to supply power for an active antenna, MMT recommends that a quarter wave stub be used to prevent disturbing the matching of the antenna and MN5010HS module. The other end of the quarter wave stub should be AC grounded with a suitable microwave quality capacitor. Please refer to the MN5010HS Design Guidelines for more information.

Signal Level	-160 to -125 dBm (typical)
Frequency	L1 (1575.42 MHz)
Return Loss	Better than -10 dB
Noise Figure	1.5 dB (typical)
Impedance	50 ohms nominal

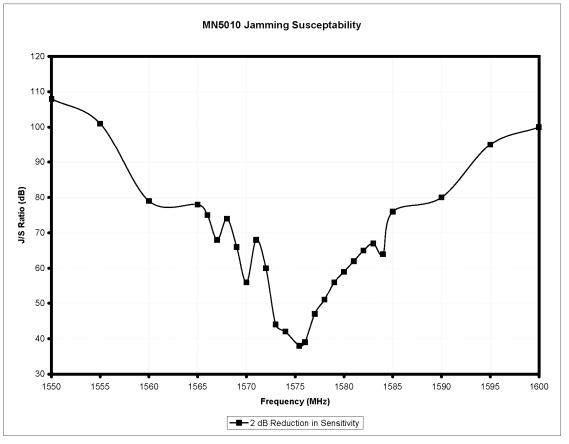
#### Table 8 – RF Signal Characteristics

#### 3.3.2 Burnout Protection

The MN5010HS GPS Receiver Module can accept signal levels up to +10 dBm with a DC voltage of  $\pm$ 15 V on the RF input pin without permanent damage to the module.

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#### 3.3.3 Jamming Performance





#### 3.4 Signal Interface

#### 3.4.1 Digital Interface Levels

 $V_{DD}$  is nominally 1.8 VDC.

Parameter	Symbol	Min	Тур	Max	Units
High Level Input Voltage	V <sub>IH</sub>	0.75*V <sub>DD</sub>		V <sub>DD</sub>	V
Low Level Input Voltage	V <sub>IL</sub>	0		0.25* V <sub>DD</sub>	V
Switching Threshold	V <sub>T</sub>		0.5* V <sub>DD</sub>		V
High Level Input Current	I <sub>IH</sub>	-10		10	uA
Low Level Input Current	I <sub>IL</sub>	-10		10	uA
High Level Output Voltage	V <sub>OH</sub>	V <sub>DD</sub> -0.2			V
Low Level Output Voltage	V <sub>OL</sub>			0.2	V

Table 9 – Digital I/O Interface Levels

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#### 3.4.2 Serial Interface

A full-duplex asynchronous serial data port provides data communications to and from the MN5010HS GPS Receiver Module. Please refer to the MN5010HS Design Guidelines for more information.

#### 3.4.3 1PPS Signal

The 1PPS signal is only valid when the receiver is in 3D navigation mode. The 1PPS signal pulses high for 1 microsecond at 1 Hz.

1PPS Signal Accuracy	200 nanoseconds
1PPS Signal Offset from UTC 1 Second Epoch	450 nanoseconds, trailing

Table 10 – 1PPS Signal Characteristics

#### 3.4.4 RESERVED Signal

Pin 4 must be tied to ground. It is recommended to go through a zero  $\Omega$  resistor.

### 4 Software Interface

#### 4.1 NMEA Data Messages

The MN5010HS supports the NMEA-018 v3.0 messages:

ID	Description	Default interval
GGA	GPS fix data	1 sec
GLL	Latitude and longitude	Ν
GSA	DOP and active satellites	1 sec
GSV	Satellites in view	5 sec (Opt 00)
RMC	Recommended Minimum GNSS Data	1 sec
VTG	Course over ground and ground speed	1 sec
ZDA	Time and date	Ν

#### Table 11 – NMEA Messages

For detailed information regarding these messages, please refer to the SiRF NMEA Reference Manual.

#### 4.2 NMEA Proprietary Commands

The MN5010HS recognizes the following NMEA proprietary commands:

ID	Description
\$PSRF100	Set Serial Port
\$PSRF101	XYZ Navigation Initialization
\$PSRF103	Query/Rate Control
\$PSRF104	LLA Navigation Initialization
\$PSRF106	Select Datum

Table 12 – Proprietary NMEA Commands

For detailed information regarding these messages, please refer to the SiRF NMEA Reference Manual.

#### 4.3 SiRF Binary Messages and Commands

For detailed information regarding the SiRF Binary protocol, please refer to the SiRF Binary Protocol Reference Manual.

## 5 Referenced Documents

SiRF NMEA Reference Manual	
SiRF Binary Protocol Reference Manual	
MN5010HS Design Guidelines	

#### Table 13 – Referenced Documents

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## 6 Packaging and Marking Information

### 6.1 Package Dimensions and Component Marking

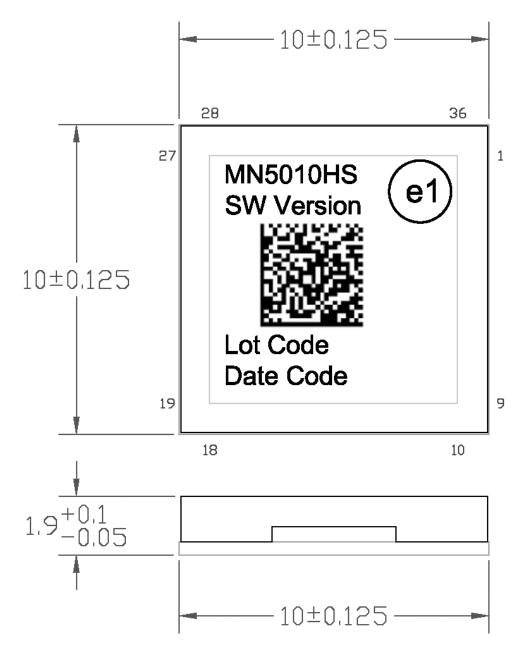


Figure 3 – Package Outline & Marking (in mm) : 36-pin LGA Note the JEDEC Pb-free symbol is also used as the pin 1 identifier for the MN5010HS.

### 6.2 Recommended PCB Footprint

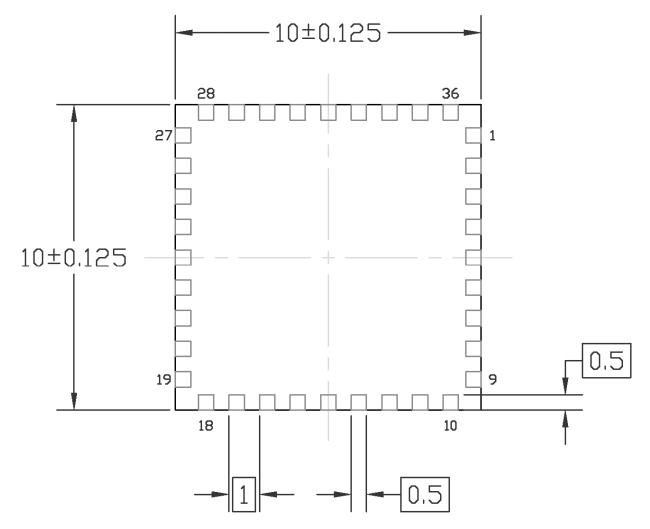


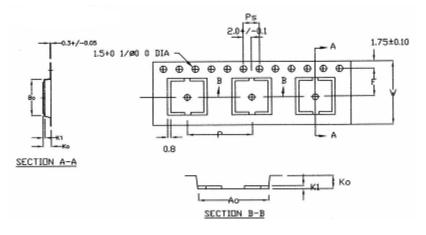
Figure 4 – Recommended PCB Footprint (in mm) – Top View

Figure 4 is a suggested PCB footprint for the MN5010HS. The user may need to adjust the pad dimensions based upon their manufacturing process. While solder mask covered traces are permissible underneath the MN5010HS, exposed vias or pads should be avoided.

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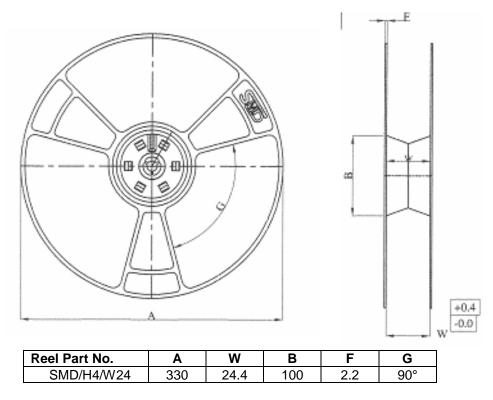
#### 6.3 Tape and Reel Information

The MN5010HS is provided in standard tape and reel, with 2K devices per reel.



Dimensions	W	Р	Ao	Во	Ко	K1	Ps	F
Nominal	24.00	16.00	10.40	10.40	1.50	0.40	4.00	11.50
Tolerance	0.3	0.1	0.1	0.1	0.1	0.1	0.1	0.1

Figure 5 - Carrier tape dimensions (in mm)





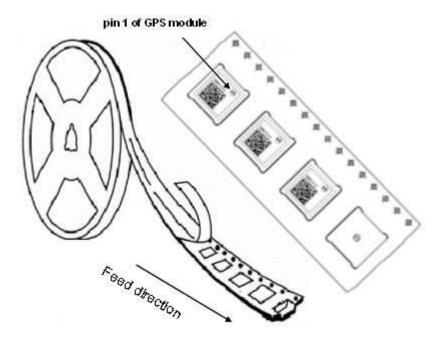
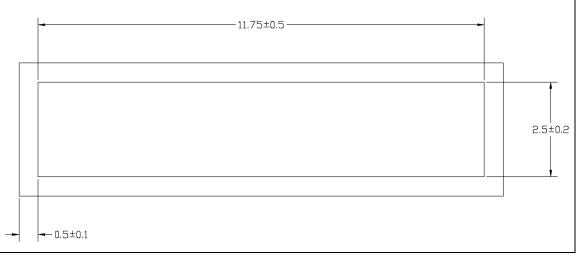
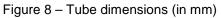


Figure 7 – Orientation in tape

### 6.4 Tube packaging

The MN5010HS is also available in tube form, with 48 devices per tube. The length of the tube is 501mm  $\pm 0.1$ mm.





#### 6.5 Recommended Reflow Profile

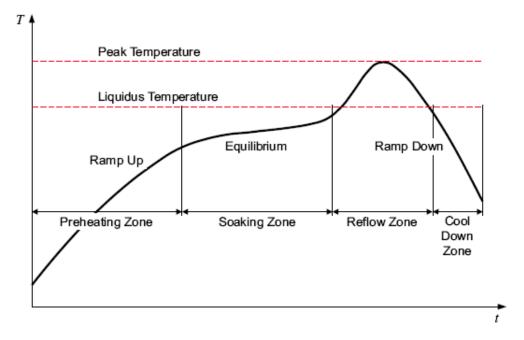
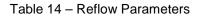


Figure 9 – Reflow Profile

Reflow Parameter	Specification	
Preheating Rate	2.5°C/second	
Soaking Temperature	140℃ to 170℃	
Soaking Time	80 seconds	
Peak Temperature	260℃	
Reflow Time over Liquidus	60 seconds	
Cool down Rate	2.5℃/second	



## 7 Ordering Information

The ordering part numbers are contained in the table below:

Ordering Part Number	Description	
MN5010HS-RS	MN5010HS in tape & reel	
MN5010HS-TS	MN5010HS in tube	

Table 15 – Ordering Information

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### 8 Notices

All reference and informational documents (including marketing information, specifications, reference designs, etc.) are provided for information only and are subject to change without notice. Reasonable efforts have been made in the preparation of these documents to assure their accuracy, however Micro Modular Technologies Pte. Ltd. assumes no liability resulting from errors or omissions in this, or any document, or from the use of the information contained herein. Micro Modular Technologies Pte. Ltd. reserves the right to make changes in the product design and specifications as needed and without notification to its users. Please check our website for the most current documentation. All information contained herein is the property of Micro Modular Technologies Pte. Ltd. and may not be copied or reproduced, other than for your information, without prior written consent.

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